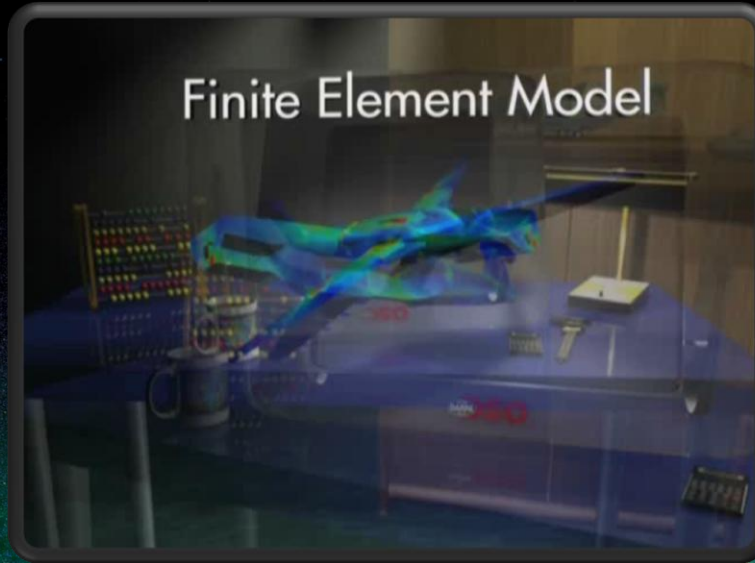




DDSIM Level 3: Damage Science

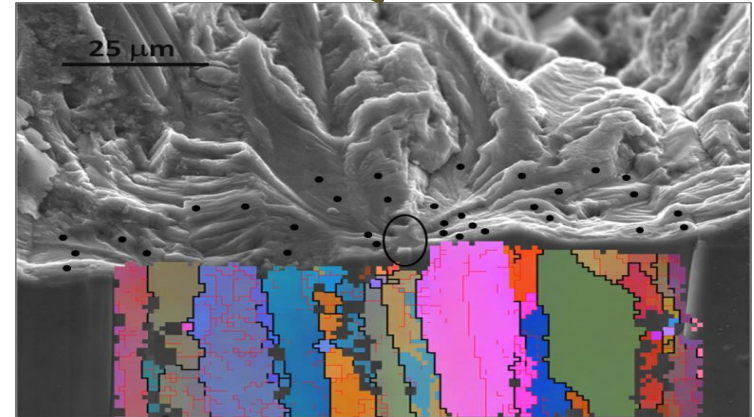
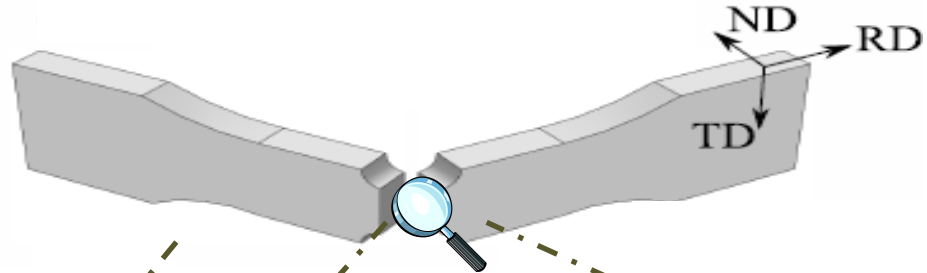


Jacob D. Hochhalter, NASA Langley

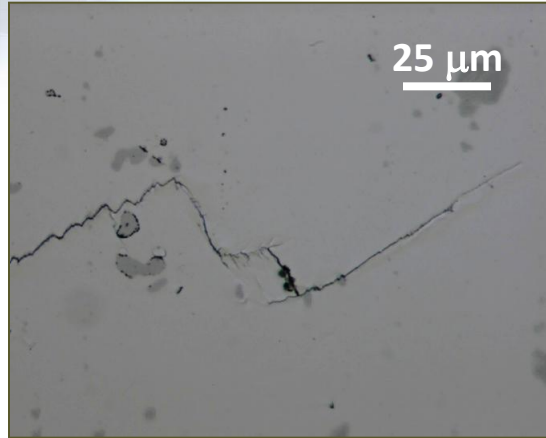
DDSIM Level 3 Objective



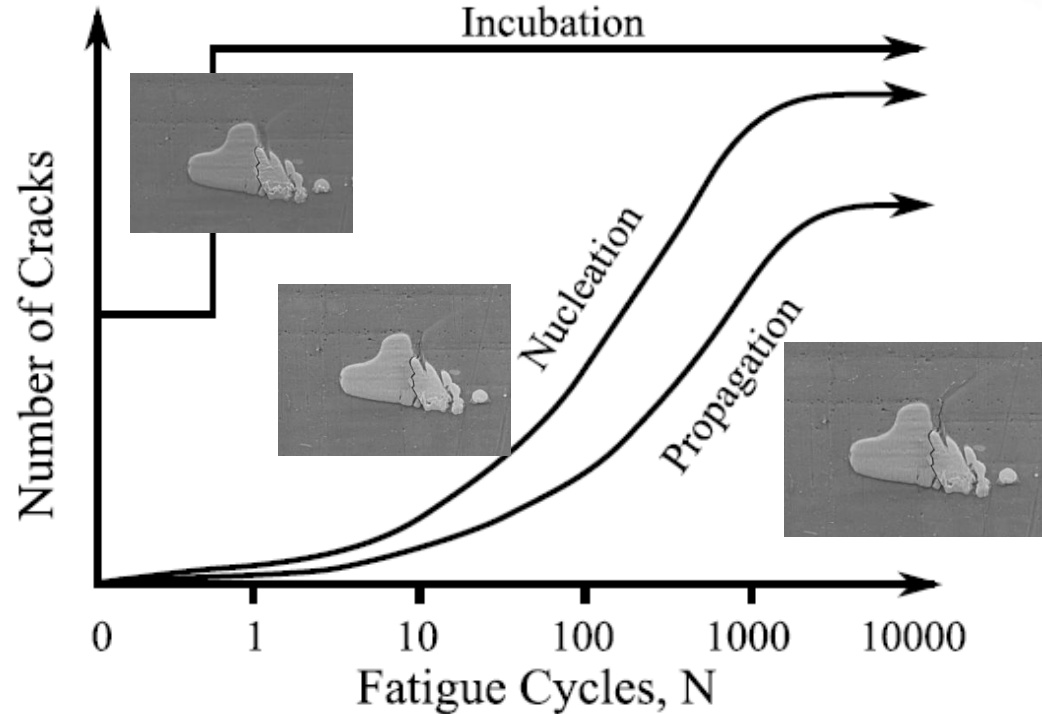
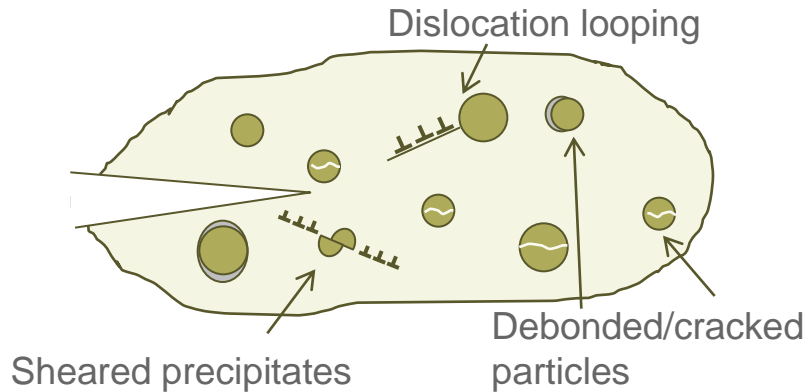
To better understand and prognose the distribution of fatigue behavior as it relates to inherent material inhomogeneities.



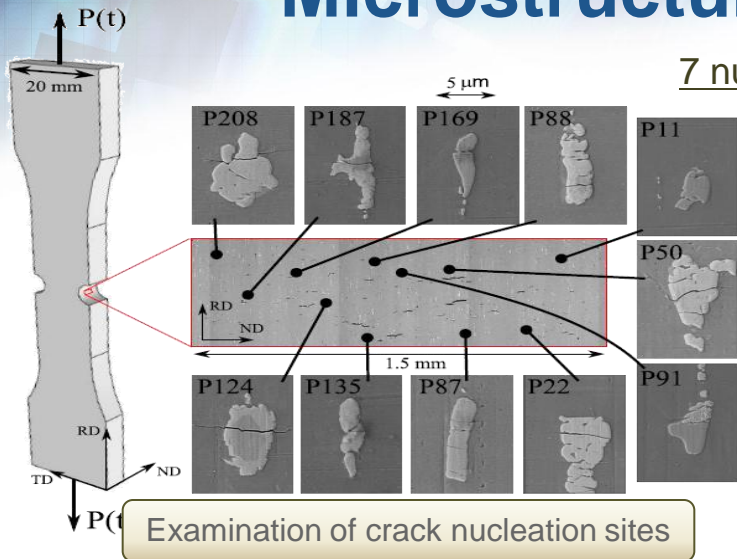
Microstructurally Small Fatigue Cracking



- Identify and isolate key microstructure features



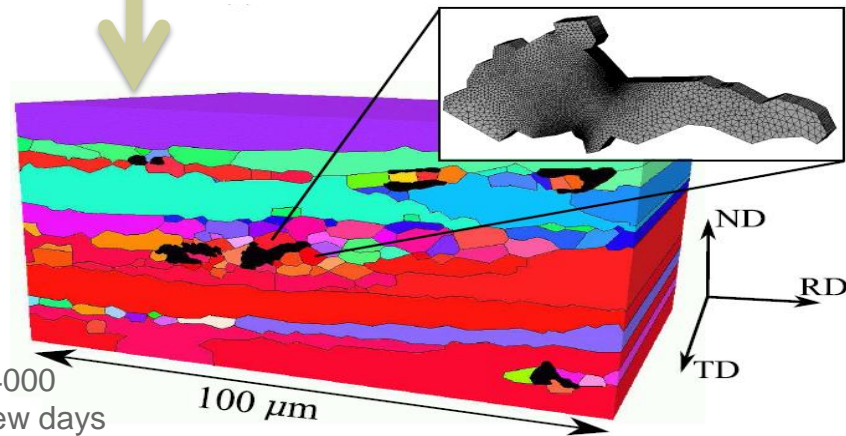
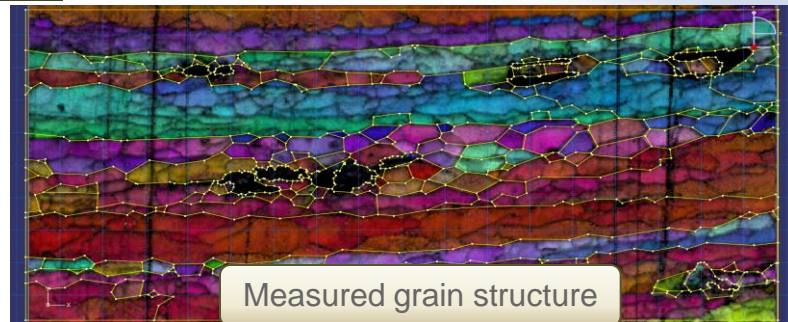
Microstructure-Replication Modeling



7 nucleated by 3000 cycles

4 never nucleated

Why?



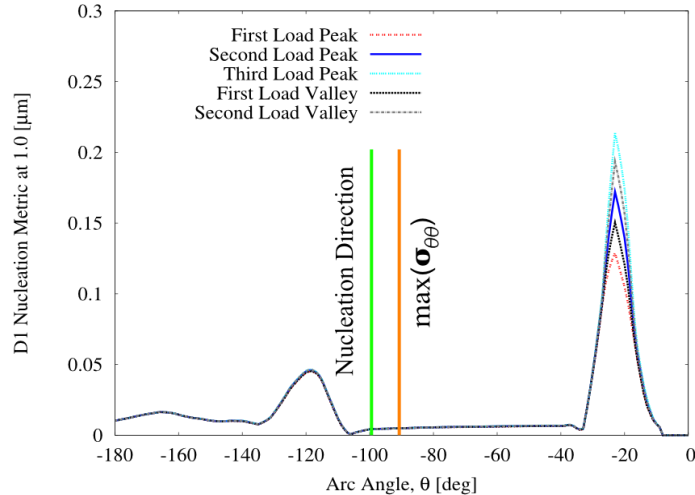
Can require upwards of 4000 cores for a few days

HPC enables simulation of microstructural mechanics: necessary to develop models that describe observed variability

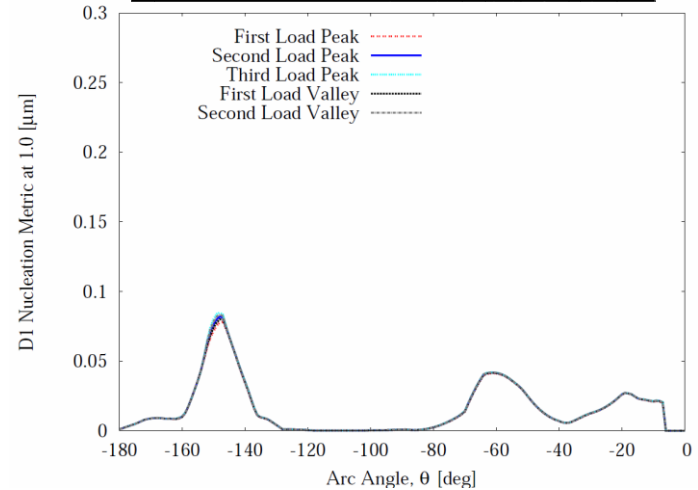
Compare & Contrast Results



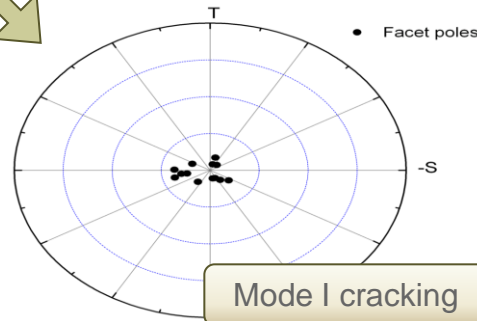
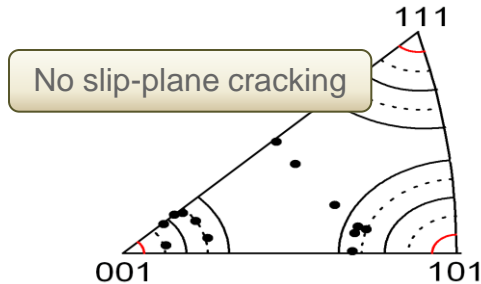
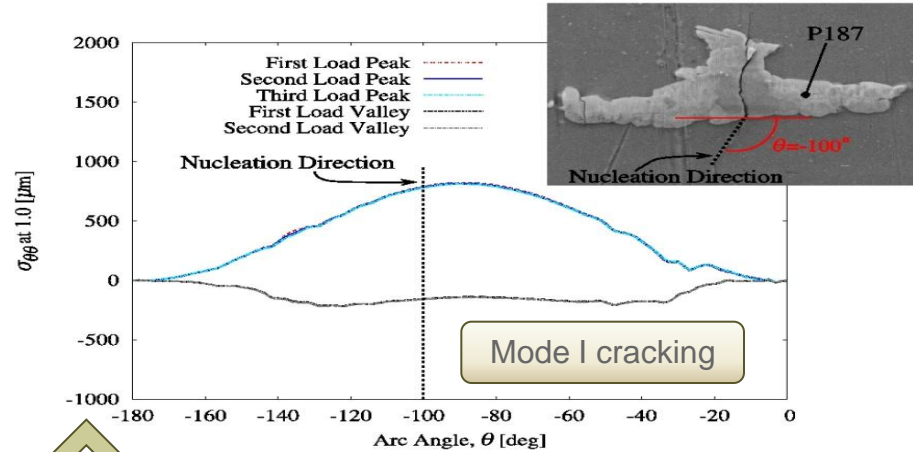
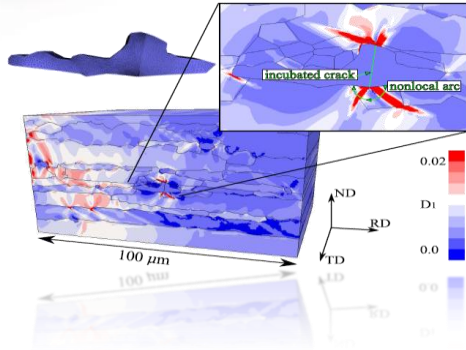
Nucleated



Did Not Nucleate



Validating Computed Results

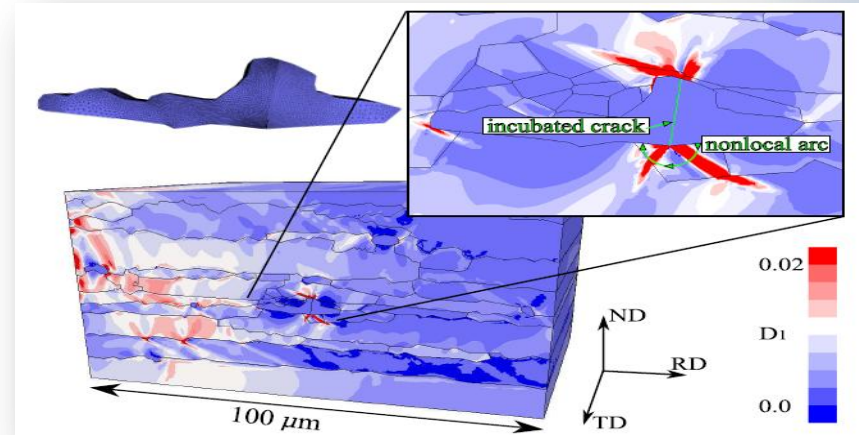
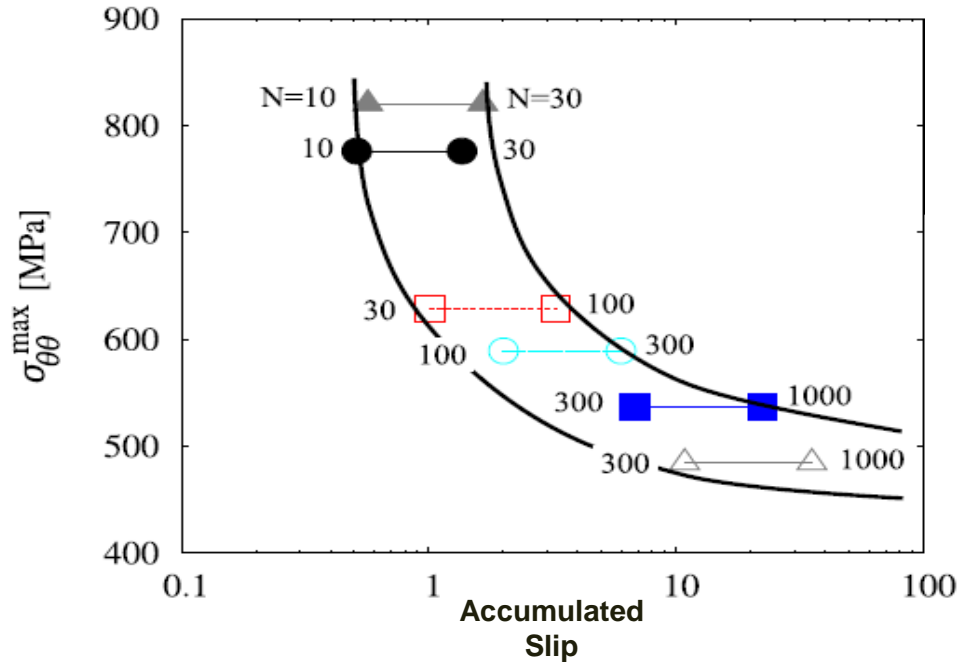


Comparing simulation results with recent measurements provides validation and corrects errors in previous models

Semi-Empirical Nucleation Model

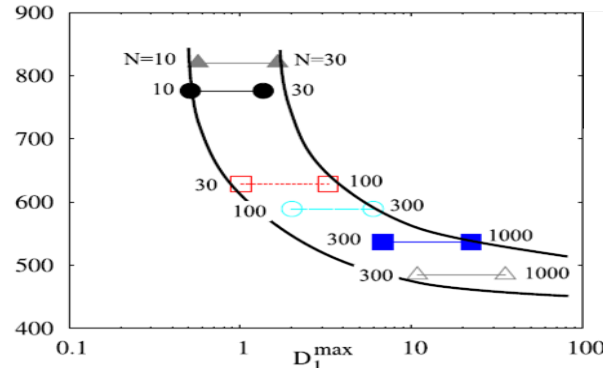
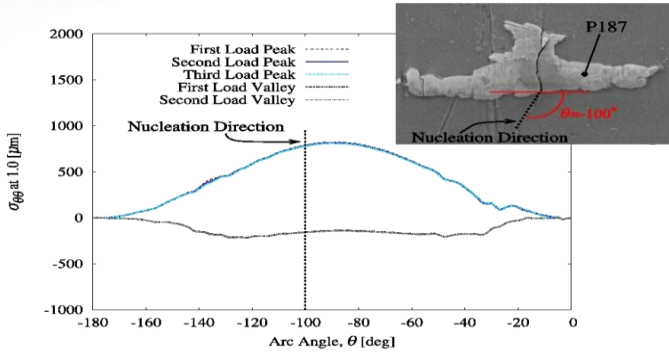


The stress required to drive nucleation reduces with accumulation of slip

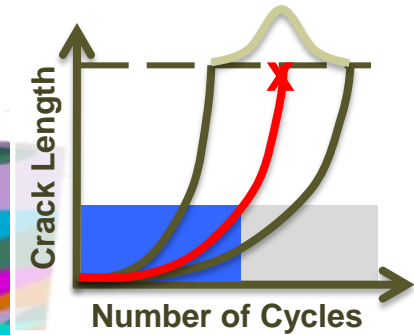
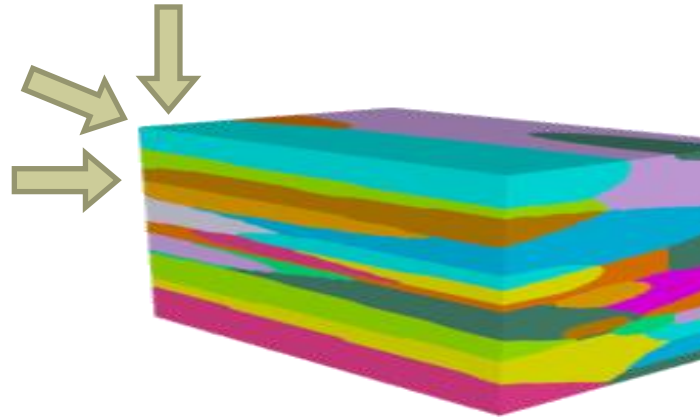
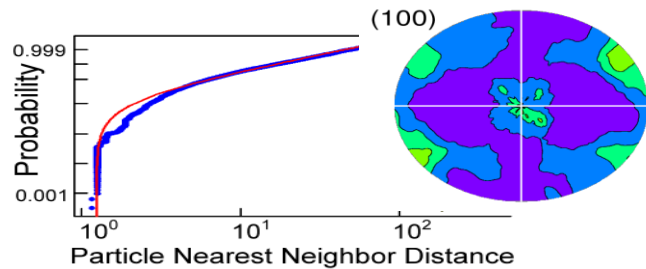


HPC simulation of several microstructures led to a model that describes observed variability

Implement Semi-Empirical Cracking Models



Modeling the mechanics that underpin **observed variability** enables design of ultra-durable materials

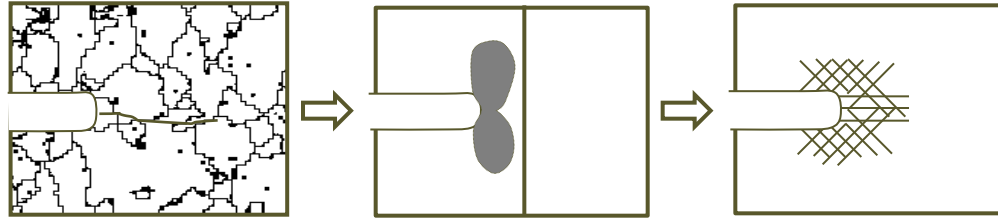


Statistical realization of microstructure

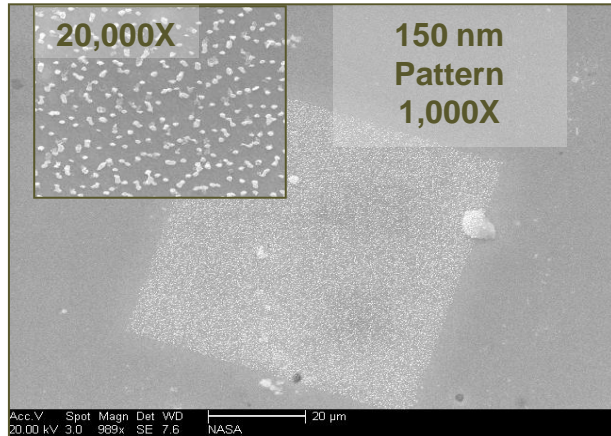
Improved Fidelity with Damage Science



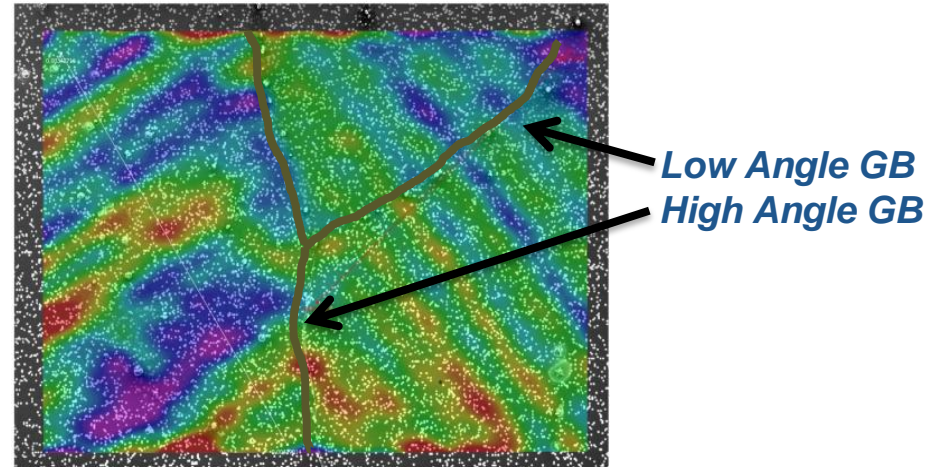
Complex alloys Simplified (cleaner) single/bi- crystals



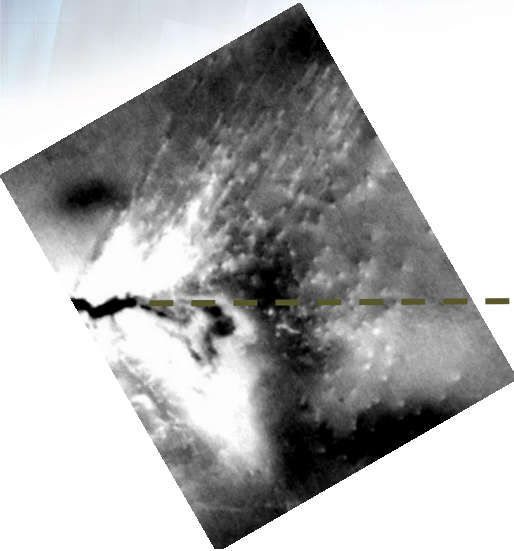
High resolution VIC 2D ® in ESEM



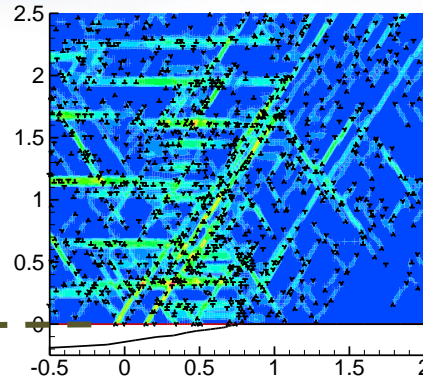
*Displacement resolution = $O(10 \text{ nm})$
Strain resolution = 10^{-4}*



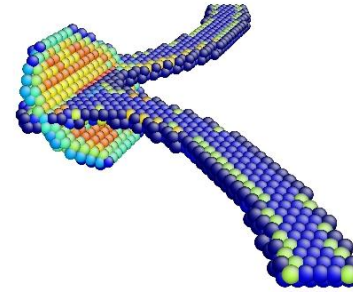
Improved Fidelity with Damage Science



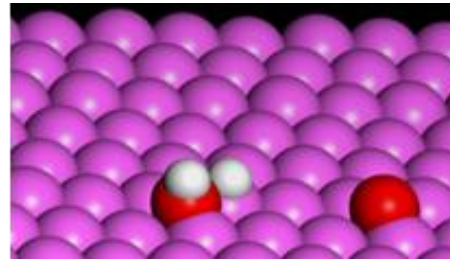
Secondary Electron Image of
Crack Tip in NiAl
Crimp et al.



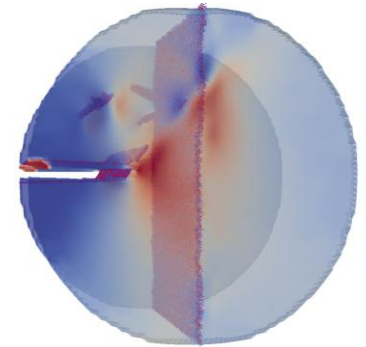
**Dislocation-Crack
Interaction**
Curtin et al.



**Dislocation-Precipitate
Interaction**
Warner et al.



**Water-Crack Surface
Interaction**
Kelly et al.



**Crack-Grain Boundary
Interaction**
Yamakov et al.